

Description

Xsis Electronics "XH6x" Series High Temperature crystal oscillators are designed and processed to operate over an extended temperature range of -55 °C to 230 °C. These oscillators are offered in a low profile, hermetically sealed resistance welded 5x7mm ceramic packages.

High temperature materials and proven processes are utilized to provide high reliability and long life at extreme temperatures.

In addition, the quartz crystal is mounted at four points to provide excellent shock and vibration resistance.

Features

- Crystal Mounted at 4 Points
- > 20KG (0.3 mS) Shock Resistance
- 1.8V, 2.5V, 3.3V & 5.0V operation options
- 100% testing over operating temperature range
- Tristate Output Option
- Low Phase Noise
- Hermetically Sealed, Ceramic Package
- Tape & Reel packaging
- Made in USA, ECCN: EAR99

Applications

- Downhole Drilling Operations
- High Shock & Vibration
- High Temperature Avionics
- Gun Launched Munitions
- Jet Engine Sensors

Package Specifications & Outline:

- Package: Ceramic 90% AL₂ O₃
- Seal: Hermetic Resistance Welded
- Weight: 0.3g typical, 0.6g Max.
- Thermal Resistance, Junction to Case (θ_{JC}): 38 °C / Watt
- Solder Reflow, Temp./Time: 260 °C Max for 10 Seconds Max.
- Pad Finish: 1.27 to 2.2 μm gold over 1.27 to 8.9 μm nickel
- Lead Material & Finish: Kovar, 40 to 70 μ inches gold over 100 to 250 µ inches Nickel

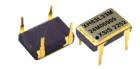
"XH6"



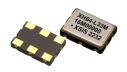
"XH61"



"XH62"



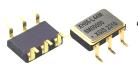
"XH63"



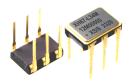
"XH64"



XH65"



XH66'



"XH67"

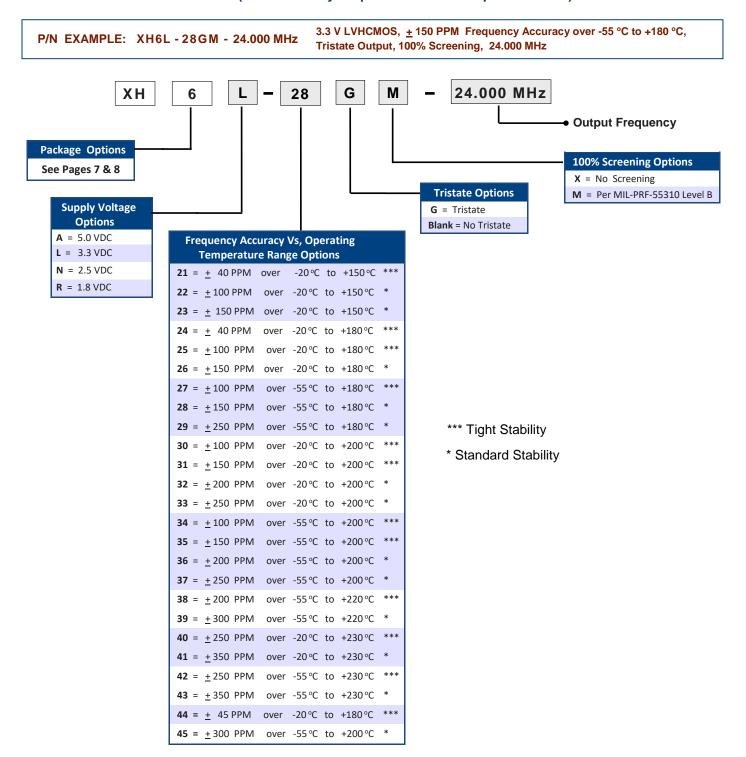
Contact Xsis Electronics at xsis@xsis.com for any special requirements.

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(1.8 VDC, 2.5 VDC, 3.3 VDC, & 5.0 VDC 500 KHz to 45 MHz)

ORDERING INFORMATION (Please build your part number from options below):



Contact Xsis Electronics at xsis@xsis.com (913-631-0448) for any special requirements.

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(1.8 VDC, 2.5 VDC, 3.3 VDC, & 5.0 VDC $\,$ 500 KHz to 45 MHz)

Electrical Specifications, 5V & 3.3V HC/ACMOS Oscillators

Parameter	5 V HC/ACMOS	3.3 V HC/ACMOS		
Output Frequency Range	500 KHz - 45 MHz	500 KHz - 45 MHz		
Frequency Stability Vs Temperature	See Ordering Information on Page 1			
Operating Temperature Range	See Ordering Information on Page 1			
Supply Voltage (Vdd)	+ 5 VDC <u>+</u> 10%	+ 3.3 VDC <u>+</u> 10%		
Input Current (no Load)	9 mA typical at 20 MHz (For Lower current option, Contact factory)	5 mA typical at 20 MHz (For Lower current option, Contact factory)		
Output Waveform	Square Wave	Square Wave		
Output Duty Cycle (at 50% Output Level)	40/60% Max. (For tighter symmetry, Contact factory)	40/60% Max. (For tighter symmetry, Contact factory)		
Output High Level	0.9 Vdd Min.	0.9 Vdd Min.		
Output Low Level	0.1 Vdd Max.	0.1 Vdd Max.		
Output Load	10K // 15 pF 50 pF Max.	10K // 15 pF 50 pF Max.		
Rise & Fall Times (Typical Load)	3 nS Max. (10% to 90% Output Levels)	4 nS Max. (10% to 90% Output Levels)		
Enable/Disable (E/D)	E/D Input ≥ 2.2V or Open : Normal Output E/D Input ≤ 0.8V: High Impedance			
Start-Up Time	10 mS Max.	10 mS Max.		
Phase Jitter (10 KHz - 20 MHz Integ.)	0.5 pS rms Typical 0.5 pS rms Typical			
Aging at 70 °C	± 3 PPM Max. first year, ± 2 PPM Max. per year thereafter			
Absolute Maximum Applied Voltage	+ 7VDC + 5VDC			
Storage Temperature	-65 °C to +125 °C -65 °C to +125 °C			

NOTE: Overall Frequency Accuracy Includes, Initial Accuracy at 25 °C, Frequency changes over Operating Temperature, Aging over 5 years, Frequency changes due to Supply Voltage & Load Variations.

For special requirements, such as, tighter output symmetry, faster start-up time, PIND screening, etc., please contact Xsis Electronics at xsis@xsis.com or call us at 913-631-0448.

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Electrical Specifications, 2.5V & 1.8V LVHCMOS Oscillators

Parameter	2.5 V HC/ACMOS	1.8 V HC/ACMOS			
Output Frequency Range	500 KHz - 45 MHz 500 KHz - 25 MHz, Max. Temperature 2 25 MHz - 45 MHz, Max. Temperature 2				
Frequency Stability Vs Temperature	See Ordering Information on Page 1				
Operating Temperature Range	See Ordering Information on Page 1				
Supply Voltage (Vdd)	+ 2.5 VDC <u>+</u> 10% + 1.8 VDC <u>+</u> 5%				
Input Current (no Load)	3.5 mA Typ. at 20 MHz (For Lower current option, Contact factory) (For Lower current option, Contact factory)				
Output Waveform	Square Wave Square Wave				
Output Duty Cycle (at 50% Output Level)	40/60% Max. 40/60% Max. (For tighter symmetry, Contact factory) (For tighter symmetry, Contact factory)				
Output High Level	0.9 Vdd Min.	0.9 Vdd Min.			
Output Low Level	0.1 Vdd Max. 0.1 Vdd Max.				
Output Load	10K // 15 pF 30 pF Max.	10K // 15 pF 30 pF Max.			
Rise & Fall Times (Typical Load)	< 30 MHz 6 nS Max. ≥ 30 MHz 3 nS Max. (10% to 90% Output Levels)	< 30 MHz 6 nS Max. ≥ 30 MHz 3 nS Max. (10% to 90% Output Levels)			
Enable/Disable (E/D)	E/D Input ≥ 0.7 Vdd or Open : Normal Output E/D Input ≤ 0.3Vdd: High Impedance				
Start-Up Time	10 mS Max.	10 mS Max.			
Phase Jitter (10 KHz - 20 MHz Integ.)	0.5 pS rms Typical 0.5 pS rms Typical				
Aging at 70 °C	± 3 PPM Max. first year, ± 2 PPM Max. per year thereafter				
Absolute Maximum Applied Voltage	+ 4.5VDC + 4.5VDC				
Storage Temperature	-65 °C to +125 °C -65 °C to +125 °C				

NOTE: Overall Frequency Accuracy Includes, Initial Accuracy at 25 °C, Frequency changes over Operating Temperature, Aging over 5 years, Frequency changes due to Supply Voltage & Load Variations.

For special requirements, such as, tighter output symmetry, faster start-up time, PIND screening, etc., please contact Xsis Electronics at xsis@xsis.com or call us at 913-631-0448.

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Packaging Options:

Standard Packaging in ESD foam trays

Tape & Reel, EIA-481-A Compliant is available at additional cost

Thermal Characteristics:

Junction to case Thermal Constant (θ_{JC}): 38 $^{\circ}\text{C}$ / Watt

Typical Phase Noise (dbc/Hz):

Output Frequency	10 Hz	100 Hz	1 KHz	10 KHz	100 KHz	1 MHz
10 MHz	- 90	-122	-145	-158	-161	-164
25 MHz	-83	-111	-135	-143	-149	-157
40 MHz	-81	-108	-133	-142	-146	-154

Environmental Specifications:

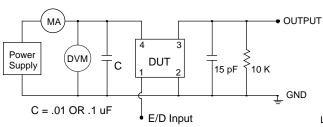
XH6x series oscillators are designed to meet or exceed the Environmental tests specified below. Customized screening and environmental testing are also available to meet your special requirements.

Test	Test Conditions	
Vibration	0.06" DA, 30 G peak, 10 - 2000 Hz, MIL-STD-202, Method 204, Cond. G	
Shock	5000 G, 0.3 mS, half-Sine, MIL-STD-883, Method 2002, Cond. D	
Temperature Cycling	MIL-STD-883, Method 1010, Cond. C	
Thermal Shock	MIL-STD-202, Method 107, Cond. B	
Seal (Fine and Gross)	MIL-STD-883, Method 1014 Cond. A & C	
Burn-in	160 Hours, 125 °C, Nominal Supply Voltage & Load	
Frequency Aging	30 days at 70 °C, ± 1.5 PPM Max.	
Altitude	MIL-STD-202, Method 105, Cond. C	
Constant Acceleration	MIL-STD-883, Method 2001, 5000 G	
Moisture Resistance	MIL-STD-202, Method 106, Vibration Sub Cycle Omitted	
Solderability	MIL-STD-202, Method 208	
Resistance to Soldering Heat	MIL-STD-202, Method 210, Cond B. or C as applicable	
Resistance to Solvents	MIL-STD-202, Method 215	
Internal Water Vapor Content	MIL-STD-883, Method 1018	
ESD Classification	MIL-STD-883, Method 3015, Class 1C, HBM 1000 to 1999	
Moisture Sensitivity Level	J-STD-020, MSL=1	

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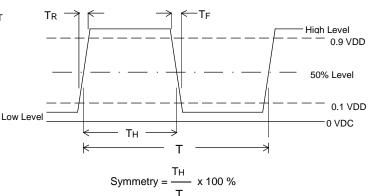
(1.8 VDC, 2.5 VDC, 3.3 VDC, & 5.0 VDC 500 KHz to 45 MHz)

HCMOS Test Circuit

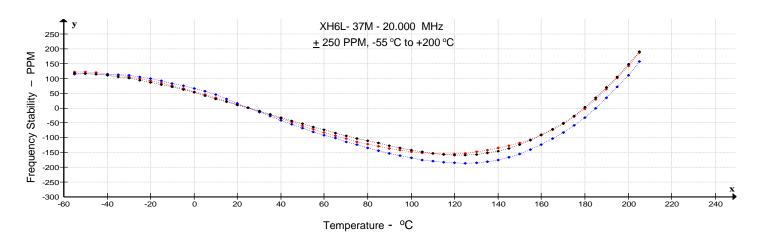


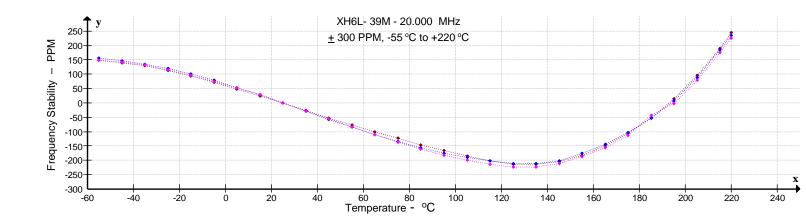
E/D (Enable/Disable) Input has an internal pull-up resistor. It can be left floating or connected to Vdd.

HCMOS Output Waveform



Typical Freq. Stability Vs. Temperature



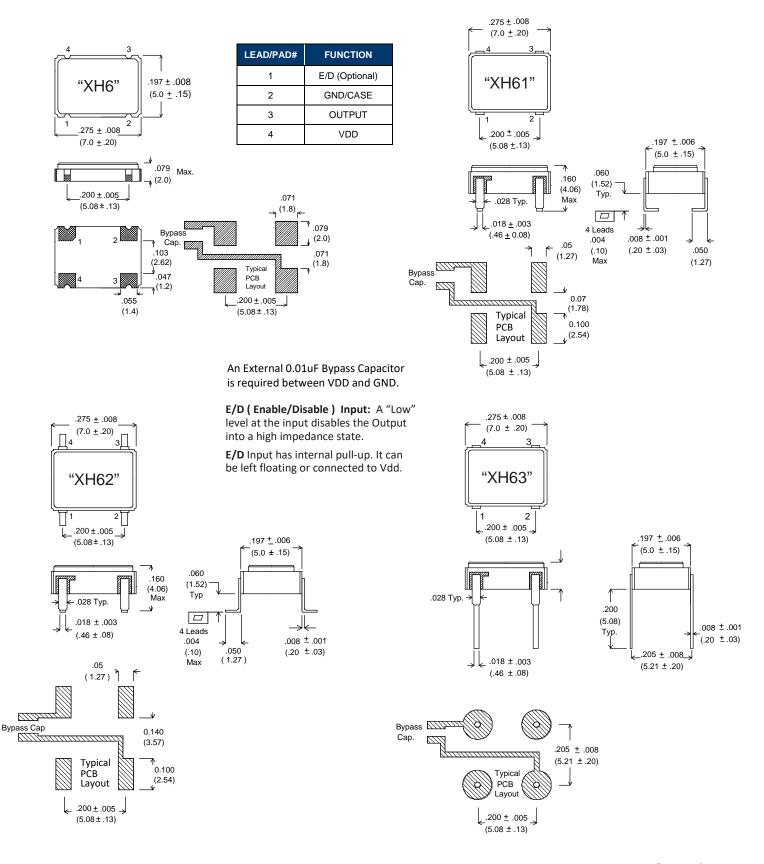


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(1.8 VDC, 2.5 VDC, 3.3 VDC, & 5.0 VDC 500 KHz to 45 MHz)

Package Outline and Pin Connections - Dimensions are in inches (mm)



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(1.8 VDC, 2.5 VDC, 3.3 VDC, & 5.0 VDC 500 KHz to 45 MHz)

Package Outline and Pin Connections - Dimensions are in inches (mm)

